PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
JIN-BIAO LIU	11/20/2006
GUANG YU	11/20/2006
SHIH-HSUN WUNG	11/20/2006
CHUN-CHI CHEN	11/20/2006

RECEIVING PARTY DATA

Name:	Foxconn Technology Co., Ltd.	
Street Address:	3-2,CHUNG SHAN ROAD	
City:	Tu-Cheng,Taipei Hsien	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11566015

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: US12315

NAME OF SUBMITTER: Jeffrey Todd Knapp

Total Attachments: 2

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PATENT

REEL: 018574 FRAME: 0813

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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1.	Jin-Biao Liu	, residing at	Shenzhen, Guangdong, China			
2.	Guang Yu	, residing at	Shenzhen, Guangdong, China			
3.	Shih-Hsun Wung	_, residing at	Tu-Cheng, Taipei, Taiwan			
4.	Chun-Chi Chen	_, residing at	Tu-Cheng, Taipei, Taiwan			
5.		_, residing at				
6.		_, residing at				
7.		_, residing at				
8.		, residing at				
hereby sell(s), assign(s) and transfer(s) unto: <u>Foxconn Technology Co.,Ltd</u> , having a principal place of business at <u>3-2, Chung Shan Road, Tu-cheng City, Taipei Hsien, Taiwan, ROC</u> hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as Heat Dissipation Device Assembly for which the undersigned						
[] prev	viously executed Ser. No suting concurrently herewith	o h	and filing date of			

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

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PATENT REEL: 018574 FRAME: 0814

1.	Jon-Boao Lou		Nov.20,2006	
	Jin-Biao Liu	inventor	Date	Witness
2.	Guang Yu Guang Yu	inventor	Nov.20,2006 Date	Witness
3.	Shih-Kun Wung Shih-Hsun Wung	inventor	Nov. 20, 2006 Date	Witness
4.	Chun-Chi Chen	inventor	Nov.20,2006 Date	Witness
5.	· · · · · · · · · · · · · · · · · · ·	inventor	Date	Witness
6.	·	inventor	Date	Witness
7.		inventor	Date	Witness
8.			Dia	With
		inventor	Date	Witness